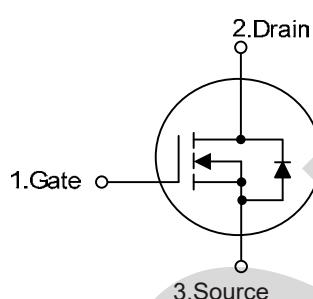
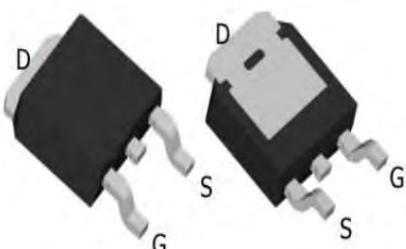


Trench N-channel Power MOSFET

MSR110N10D

TO-252



V_{DS}	100	V
$R_{DS(on),TYP}@ V_{GS}=10\text{ V}$	95	$\text{m}\Omega$
I_D	15	A

Features

- 1、Low on – resistance
- 2、Package TO-252
- 3、TrenchFET Power MOSFET

Applications

- 1、Uninterruptible Power Supply(UPS)
- 2、Inverter System

Maximum ratings, at TA =25°C, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V(BR)DSS$	Drain-Source breakdown voltage	100	V
V_{GS}	Gate-Source voltage	± 20	V
I_D	Continuous drain current @ $V_{GS}=10\text{V}$	$T_C=25^\circ\text{C}$	A
		$T_C=100^\circ\text{C}$	A
I_{DM}	Pulse drain current tested (Note 1)	$T_C=25^\circ\text{C}$	A
P_D	Maximum power dissipation	$T_C=25^\circ\text{C}$	W
$T_{STG,TJ}$	Storage and Junction Temperature Range	-55 to + 150	°C

Thermal Characteristics

Symbol	Parameter	Typical	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case	2.72	°C/W

Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
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Static Electrical Characteristics @T_j=25°C (unless otherwise stated)

V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.6	3.0	V
R _{D(on)}	Drain-Source On-State Resistance (Note 2)	V _{GS} =10V, I _D =10A	--	95	110	mΩ
		V _{GS} =4.5V, I _D =5A	--	100	130	mΩ

Dynamic Electrical Characteristics@T_j = 25°C (unless otherwise stated)

C _{iss}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, f=1MHz	--	632	--	pF
C _{oss}	Output Capacitance		--	37	--	pF
C _{rss}	Reverse Transfer Capacitance		--	21	--	pF
Q _g	Total Gate Charge	V _{DS} =80V, I _D =10A , V _{GS} =10V	--	19.2	--	nC
Q _{gs}	Gate-Source Charge		--	3.4	--	nC
Q _{gd}	Gate-Drain Charge		--	6.1	--	nC

Switching Characteristics

Td(on)	Turn-on Delay Time	$V_{DD}=50V$, $R_L=2.8\Omega$, $R_{REN}=6.0\Omega$, $I_D=10A$	--	12.6	--	ns
Tr	Turn-on Rise Time		--	6	--	ns
Td(off)	Turn-Off Delay Time		--	32.5	--	ns
Tf	Turn-Off Fall Time		--	4.3	--	ns

Source -Drain Diode Characteristics @Tj = 25°C (unless otherwise stated)

I _S	Maximum Continuous Drain to Source Diode Forward Current	--	--	15	A	
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current	--	--	60	A	
V _{SD}	Forward on voltage	I _S =10A, V _{GS} =0V	--	--	1.2	V

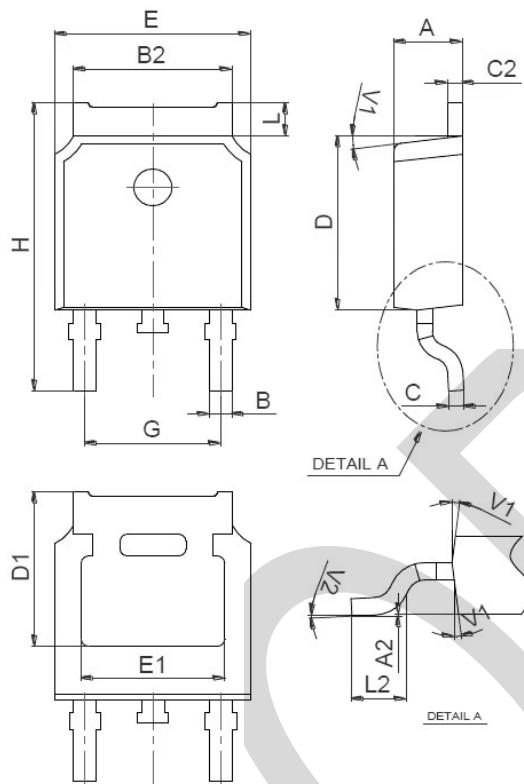
NOTE:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%.

PACKAGE OUTLINE DIMENSIONS

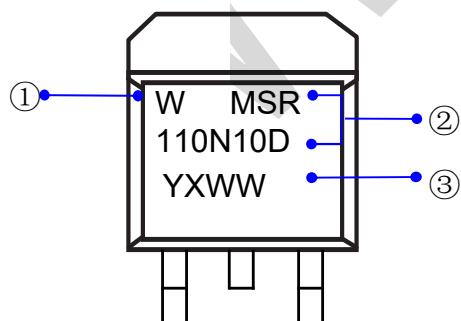
Note:unit mm

TO-252



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Marking Information



①W : Company's trademark

②Product model : MSR110N10D

③PDC information :

Y X WW

WW:Week code(01 to 53)

X:Internal identification code

Y:Year code(ex:0=2020)